EXPRESS MAIL LABEL NO. I	EJ 636	
Form PTO-1595		, 18818, 11611 EB101 11611 EB101 18112 18111 BB112 1

OMB No. 0651-0011 (exp. 4/94)

(Rev. 6-93)

REC

101089021 **PATENTS ONLY**

U.S. DEPARTMENT OF COMMERCE

3 SHEET Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks:	Please record the attached original documents or copy there		
Name of conveying party(ies):	2. Name and address of receiving party(ies):		
Hitoshi Takeda	Name: K. K. Endo Seisakusho		
	Internal Address:		
Additional name(s) of conveying party(ies) attached? □Yes ■No 3. Nature of conveyance:	Street Address: 1845, Ohaza-Higashiohta,		
■ Assignment □ Merger	Tsubame-shi		
☐ Security Agreement ☐ Change of Name	City: <u>Niigata-ken</u> Country: <u>Japan</u>		
□ Other	Additional name(s) & address(es) attached? ☐ Yes ■ No		
Execution Date: <u>June 7, 1999</u>			
4. Application number(s) or patent number(s):			
If this document is being filed with a new application, the	execution date of the application is: June 7, 1999		
A. Datant Application No. (a)			
A. Patent Application No.(s)	B. Patent No.(s)		
Additional numbers	attached? □ Yes ■ No		
Name and address of party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved:		
Name: Michael J. McGovern	7. Total Fee (37 CFR 34)		
Internal Address: Quarles & Brady LLP	□ Enclosed		
	■ Authorized to be charged to deposit account ✓		
	a transmitted to be enarged to deposit decount		
Street Address: <u>411 East Wisconsin Avenue</u>	8. Deposit account number		
	17-0055 (Attach duplicate copy of this page if paying by deposit account)		
City: <u>Milwaukee</u> State: <u>WI</u> Zip: <u>53202</u>	(Amon depresse copy of this page is paying by deposit account)		
7/08/1999 DHGUYEN 00000195 170055 09340308	USE THIS SPACE		
FC:581 40.00 CH			
9. Statement and signature			
To the best of my knowledge and belief, the foregoing in truecopy of the original document.	information is true and correct and any attached copy is a		
On	1006/6		
Michael J. McGovern	hal . / Let June 28, 1999		
	Signature Date Signature Date Sincluding cover sheet, attachments and documents 2		
rotal number of page	s including cover sheet, attachments and document: 2		

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks, Box Assignments Washington, D.C. 20231

520373.90158

QBMKE\4389430.1

PATENT

ASSIGNMENT

Tsubame-shi, Niigata-ken, WHEREAS, I, Hitoshi Takeda of Japan have made certain inventions which are described in an application for Letters Patent of the United States entitled ____ executed by me on even GOLF CLUB date herewith preparatory to obtaining United States Letters Patent therefor, and WHEREAS, K.K.ENDO SEISAKUSHO WHEREAS, K.K.ENDO SEISAKUSHO (hereinafter referred to as said Company), a <u>Japanese</u> corporation having a place of business at <u>Niigata-ken</u>, Japan is desirous of acquiring the entire interest in said inventions throughout the United States of America and the territories thereof, for all other countries and under all international agreements, NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, receipt whereof is hereby acknowledged, I hereby sell, assign and transfer unto said Company, its successors and assigns, the entire right, title and interest throughout the United States of America and the territories thereof, for all foreign countries and under all international agreements in and to said inventions, the aforesaid application, all other applications hereafter filed in the United States, in any other country, or under any international agreement based in whole or in part on said inventions, and all Letters Patents granted upon said applications by the United States, by any other country or under any international agreement, and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to said Company. I further grant to said Company, its successors and assigns, the right to claim for any of said applications the full benefits and priority rights of any international agreement between the United States and any foreign country or countries or between any other countries. I hereby warrant that I have the full right to make the conveyance herein, and I hereby covenant that I, my heirs, legal representatives and assigns, will when requested, communicate to said Company, its representatives, successors and assigns, all facts known respecting said inventions, execute all divisional, continuing, reissue, reexamination and foreign or international applications, together with individual assignments therefor, make all rightful oaths, sign all lawful papers, testify in any legal proceeding and generally do everything possible to aid said Company, its successors and assigns, in the obtaining of Letters Patent. IN TESTIMONY WHEREOF, I have hereunto set my hand and seal at the location and on the date indicated with my signature. HITOSHI TAKEDA (SEAL) Date: June 7, 1999 Location: Tsubame-shi, Niigata-ken, Japan Marion Makes.

RECORDED: 06/28/1999

PATENT REEL: 010073 FRAME: 0077